

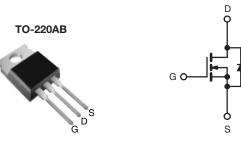
Vishay Siliconix

RoHS

COMPLIANT

Power MOSFET

PRODUCT SUMMARY					
V _{DS} (V)	100				
R _{DS(on)} (Ω)	$V_{GS} = 10 V$ 0.16				
Q _g (Max.) (nC)	26				
Q _{gs} (nC)	5.5				
Q _{gd} (nC)	11				
Configuration	Single				



N-Channel MOSFET

FEATURES

- Dynamic dV/dt Rating
- Repetitive Avalanche Rated
- 175 °C Operating Temperature
- Fast Switching
- Ease of Paralleling
- Simple Drive Requirements
- Compliant to RoHS Directive 2002/95/EC

DESCRIPTION

Third generation Power MOSFETs from Vishay provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effectiveness.

The TO-220AB package is universally preferred for all commercial-industrial applications at power dissipation levels to approximately 50 W. The low thermal resistance and low package cost of the TO-220AB contribute to its wide acceptance throughout the industry.

ORDERING INFORMATION			
Package	TO-220AB		
Lead (Pb)-free	IRF530PbF		
Lead (FD)-liee	SiHF530-E3		
SnPb	IRF530		
SIFD	SiHF530		

ABSOLUTE MAXIMUM RATINGS ($T_C = 25$ °C, unless otherwise PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-Source Voltage			V _{DS}	100	- V	
Gate-Source Voltage			V _{GS}	± 20		
Continuous Drain Current	V at 10.V	T _C = 25 °C		14		
	V _{GS} at 10 V	T _C = 100 °C	ID	10	А	
Pulsed Drain Current ^a			I _{DM}	56		
Linear Derating Factor				0.59	W/°C	
Single Pulse Avalanche Energy ^b			E _{AS}	69	mJ	
Repetitive Avalanche Current ^a			I _{AR}	14	A	
Repetitive Avalanche Energy ^a			E _{AR}	8.8	mJ	
Maximum Power Dissipation $T_{C} = 25 \text{ °C}$			P _D	88	W	
Peak Diode Recovery dV/dt ^c			dV/dt	5.5	V/ns	
Operating Junction and Storage Temperature Range			T _J , T _{stg}	- 55 to + 175		
Soldering Recommendations (Peak Temperature)	for	10 s		300 ^d	- °C	
Mounting Torque	6.00 or 1	0.00		10	lbf ⋅ in	
Mounting Torque	6-32 or M3 screw			1.1	N · m	

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).

b. V_{DD} = 25 V, starting T_J = 25 °C, L = 528 µH, R_g = 25 Ω , I_{AS} = 14 A (see fig. 12).

c. $I_{SD} \le 14$ A, dI/dt ≤ 140 A/µs, $V_{DD} \le V_{DS}$, $T_J \le 175$ °C.

d. 1.6 mm from case.

* Pb containing terminations are not RoHS compliant, exemptions may apply

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PARAMETER	SYMBOL	TYP.		MAX.	MAX.		UNIT		
Maximum Junction-to-Ambient	R _{thJA}	-		62					
Case-to-Sink, Flat, Greased Surface	R _{thCS}	0.50 -			°C/W				
Maximum Junction-to-Case (Drain)	R _{thJC}	-		1.7		1			
			I						
SPECIFICATIONS ($T_J = 25 \text{ °C}$, u	nless otherw	ise noted)							
PARAMETER	SYMBOL		CONDITION	S	MIN.	TYP.	MAX.	UNIT	
Static		1				•	•		
Drain-Source Breakdown Voltage	V _{DS}	$V_{GS} = 0$	0 V, I _D = 250	μA	100	-	-	V	
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_J$	Reference	to 25 °C, I _D	= 1 mA	-	0.12	-	V/°C	
Gate-Source Threshold Voltage	V _{GS(th)}	$V_{DS} = V$	/ _{GS} , I _D = 250	μA	2.0	-	4.0	V	
Gate-Source Leakage	I _{GSS}	Vo	_{GS} = ± 20 V		-	-	± 100	nA	
Zara Cata Valtaga Drain Current	I	V _{DS} = 1	100 V, V _{GS} =	0 V	-	-	25		
Zero Gate Voltage Drain Current	IDSS	V _{DS} = 80 V, V	V _{DS} = 80 V, V _{GS} = 0 V, T _J = 150 °C		-	-	250	μA	
Drain-Source On-State Resistance	R _{DS(on)}	$V_{GS} = 10 V$	I _D =	8.4 A ^b	-	-	0.16	Ω	
Forward Transconductance	9 _{fs}	$V_{DS} = 50 \text{ V}, \text{ I}_{D} = 8.4 \text{ A}^{b}$		5.1	-	-	S		
Dynamic									
Input Capacitance	C _{iss}	$V_{GS} = 0 V,$		-	670	-	pF		
Output Capacitance	C _{oss}	V _{DS} = 25 V,		-	250	-			
Reverse Transfer Capacitance	C _{rss}	f = 1.0 MHz, see fig. 5		-	60	-			
Total Gate Charge	Qg			-	-	26	nC		
Gate-Source Charge	Q _{gs}	$V_{GS} = 10 V$ $I_D = 14 A, V_{DS} = 80 V,$	-	-	5.5				
Gate-Drain Charge	Q _{gd}	-	see fig. 6 and 13 ^b		-	-	11	1	
Turn-On Delay Time	t _{d(on)}				-	10	-		
Rise Time	t _r				-	34	-	1	
Turn-Off Delay Time	t _{d(off)}	$V_{DD} = 50 \text{ V}, I_D = 14 \text{ A}$ $\text{R}_\text{g} = 12 \ \Omega, \text{R}_\text{D} = 3.6 \ \Omega, \text{ see fig. } 10^\text{b}$		-	23	-	ns		
Fall Time	t _f			-	24	-			
Internal Drain Inductance	L _D	Between lead, 6 mm (0.25") fro	·		-	4.5	-		
Internal Source Inductance	L _S	package and center of die contact		-	7.5	-	nH		
Drain-Source Body Diode Characteristic	s							I	
Continuous Source-Drain Diode Current	ا _S	MOSFET symbol showing the integral reverse p - n junction diode		-	-	14	A		
Pulsed Diode Forward Currenta	I _{SM}			-	-	56			
Body Diode Voltage	V _{SD}	$T_J=25~^\circ\text{C},~I_S=14~\text{A},~V_{GS}=0~\text{V}^{\text{b}}$		-	-	2.5	V		
Body Diode Reverse Recovery Time	t _{rr}	- T _J = 25 °C, I _F = 14 A, dl/dt = 100 A/μs ^b		-	150	280	ns		
Body Diode Reverse Recovery Charge	Q _{rr}			-	0.85	1.7	μC		
Forward Turn-On Time	t _{on}	Intrinsic turn-on time is negligible (turn			-on is do	minated b	v Loand		

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).

b. Pulse width \leq 300 µs; duty cycle \leq 2 %.

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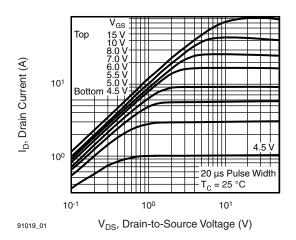


Fig. 1 - Typical Output Characteristics, T_C = 25 °C

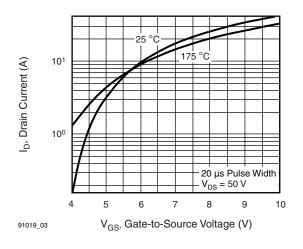


Fig. 3 - Typical Transfer Characteristics

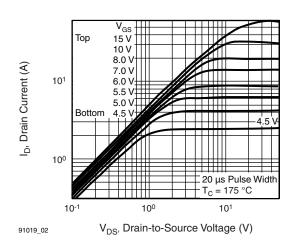


Fig. 2 - Typical Output Characteristics, $T_C = 175 \ ^{\circ}C$

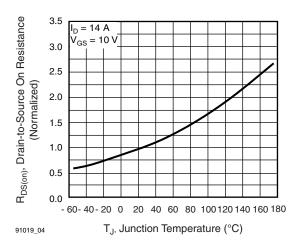


Fig. 4 - Normalized On-Resistance vs. Temperature

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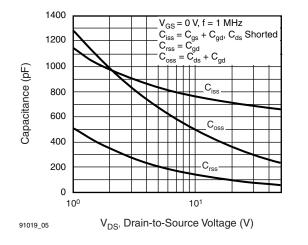


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

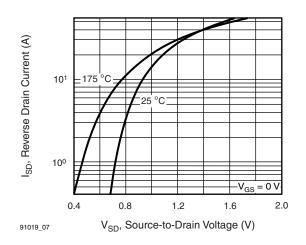


Fig. 7 - Typical Source-Drain Diode Forward Voltage

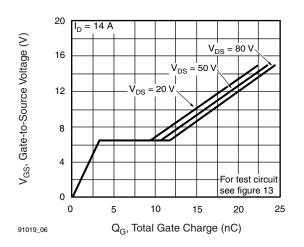


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage

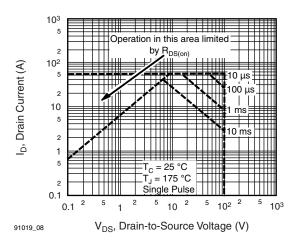
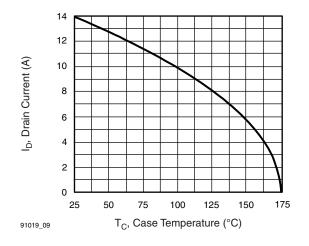


Fig. 8 - Maximum Safe Operating Area

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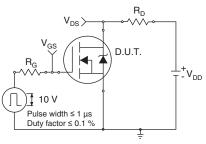


Fig. 10a - Switching Time Test Circuit

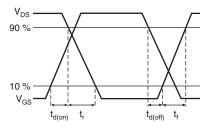


Fig. 9 - Maximum Drain Current vs. Case Temperature

Fig. 10b - Switching Time Waveforms

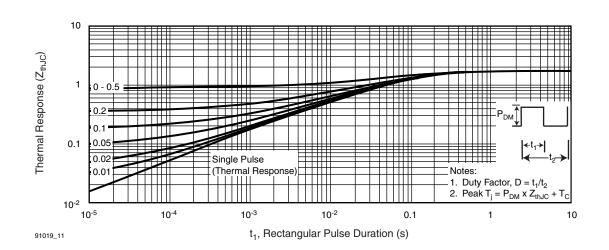


Fig. 11 - Maximum Effective Transient Thermal Impedance, Junction-to-Case

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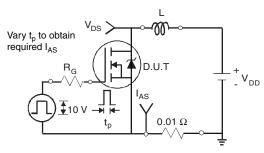


Fig. 12a - Unclamped Inductive Test Circuit

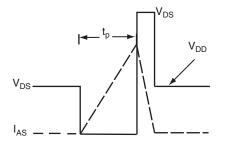


Fig. 12b - Unclamped Inductive Waveforms

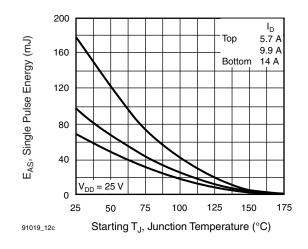


Fig. 12c - Maximum Avalanche Energy vs. Drain Current

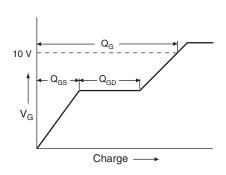


Fig. 13a - Basic Gate Charge Waveform

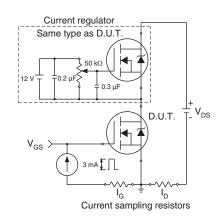
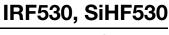


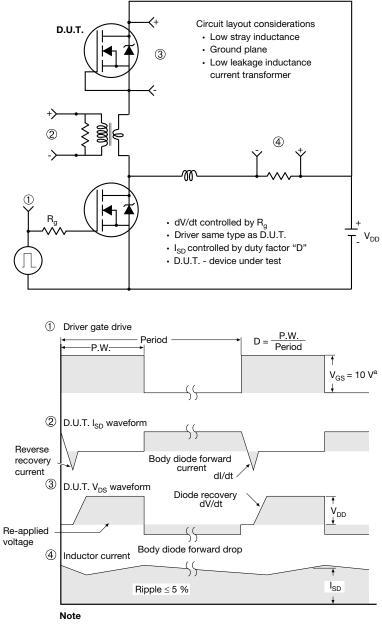
Fig. 13b - Gate Charge Test Circuit



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Peak Diode Recovery dV/dt Test Circuit



a. $V_{GS} = 5 V$ for logic level devices

Fig. 14 - For N-Channel

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TO-220-1



DIM.	MILLIN	IETERS	INCHES		
DIN.	MIN.	MAX.	MIN.	MAX.	
А	4.24	4.65	0.167	0.183	
b	0.69	1.02	0.027	0.040	
b(1)	1.14	1.78	0.045	0.070	
С	0.36	0.61	0.014	0.024	
D	14.33	15.85	0.564	0.624	
E	9.96	10.52	0.392	0.414	
е	2.41	2.67	0.095	0.105	
e(1)	4.88	5.28	0.192	0.208	
F	1.14	1.40	0.045	0.055	
H(1)	6.10	6.71	0.240	0.264	
J(1)	2.41	2.92	0.095	0.115	
L	13.36	14.40	0.526	0.567	
L(1)	3.33	4.04	0.131	0.159	
ØР	3.53	3.94	0.139	0.155	
Q	2.54	3.00	0.100	0.118	
ECN: X15-0364-Rev. C, 14-Dec-15 DWG: 6031					

Note

- M^{\star} = 0.052 inches to 0.064 inches (dimension including protrusion), heatsink hole for HVM

Package Picture					
ASE		Xi'an			
		IRF 9510 744K AB			

Revison: 14-Dec-15

1 For technical questions, contact: <u>hvm@vishay.com</u> Document Number: 66542

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